



PATENT

#10/c 8/14/02
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Cobbley et al.

Serial No.: 09/639,486

Filed: August 14, 2000

For: METHOD OF ATTACHING SOLDER
BALLS TO BGA PACKAGE UTILIZING A
TOOL TO PICK AND DIP THE SOLDER
BALL IN FLUX

Examiner: Z. Pittman

Group Art Unit: 1725

Attorney Docket No.: 3636.1US (97-1349.1)

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AMENDMENT

Box RCE
Commissioner for Patents
Washington, D.C. 20231

Sir:

This amendment is in response to the Final Office Action of May 9, 2002, whose initial period of response is set to expire on August 9, 2002 and the Advisory Action of July 17, 2002.

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